

SKM 75GB173D



SEMITRANS[®] 2

IGBT Modules

SKM 75GB173D

Features

- N channel, Homogeneous Si
- Low inductance case
- Very low tail current with low temperature dependence
- High short circuit capability, self limiting to $6 \times I_{Cnom}$
- Latch-up free
- Fast & soft inverse CAL diodes
- Isolated copper baseplate using DCB Direct Copper Bonding
- Large clearance (10 mm) and creepage distance (20 mm)

Typical Applications

- AC inverter drives on mains 575 - 750 V_{AC}
- DC bus voltage 750 - 1200 V_{DC}
- Public transport (auxiliary syst.)
- Switching (not for linear use)



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Absolute Maximum Ratings		$T_c = 25\text{ }^\circ\text{C}$, unless otherwise specified			
Symbol	Conditions	Values		Units	
IGBT					
V_{CES}	$T_j = 25\text{ }^\circ\text{C}$	1700		V	
I_C	$T_j = 150\text{ }^\circ\text{C}$	$T_{case} = 25\text{ }^\circ\text{C}$	75		A
		$T_{case} = 80\text{ }^\circ\text{C}$	50		A
I_{CRM}	$I_{CRM} = 2 \times I_{Cnom}$	100		A	
V_{GES}		± 20		V	
t_{psc}	$V_{CC} = 1200\text{ V}; V_{GE} \leq 20\text{ V}; T_j = 125\text{ }^\circ\text{C}$ $V_{CES} < 1700\text{ V}$	10		μs	
Inverse Diode					
I_F	$T_j = 150\text{ }^\circ\text{C}$	$T_{case} = 25\text{ }^\circ\text{C}$	60		A
		$T_{case} = 80\text{ }^\circ\text{C}$	40		A
I_{FRM}	$I_{FRM} = 2 \times I_{Fnom}$	100		A	
I_{FSM}	$t_p = 10\text{ ms}; \text{sin.}$	$T_j = 150\text{ }^\circ\text{C}$	550		A
Module					
$I_{t(RMS)}$		200		A	
T_{vj}		- 40 ... + 150		$^\circ\text{C}$	
T_{stg}		-40...+125		$^\circ\text{C}$	
V_{isol}	AC, 1 min.	4000		V	

Characteristics		$T_c = 25\text{ }^\circ\text{C}$, unless otherwise specified				
Symbol	Conditions	min.	typ.	max.	Units	
IGBT						
$V_{GE(th)}$	$V_{GE} = V_{CE}; I_C = 4\text{ mA}$	4,8	5,5	6,2	V	
I_{CES}	$V_{GE} = 0\text{ V}; V_{CE} = V_{CES}$	$T_j = 25\text{ }^\circ\text{C}$	0,1		0,3	mA
		$T_j = 125\text{ }^\circ\text{C}$	1,65		1,9	V
V_{CE0}			1,9	2,15	V	
r_{CE}	$V_{GE} = 20\text{ V}$	$T_j = 25\text{ }^\circ\text{C}$	35		40	$\text{m}\Omega$
		$T_j = 125\text{ }^\circ\text{C}$	46		57	$\text{m}\Omega$
$V_{CE(sat)}$	$I_{Cnom} = 50\text{ A}; V_{GE} = 15\text{ V}$	$T_j = 25\text{ }^\circ\text{C}_{chiplev.}$	3,4		3,9	V
		$T_j = 125\text{ }^\circ\text{C}_{chiplev.}$	4,2		5	V
C_{ies}	$V_{CE} = 25; V_{GE} = 0\text{ V}$	8			nF	
C_{oes}		0,64			nF	
C_{res}		0,25			nF	
Q_G	$V_{GE} = -8\text{V}...+15\text{V}$	650			nC	
$t_{d(on)}$	$R_{Gon} = 12\text{ }\Omega$	$V_{CC} = 1200\text{V}$ $I_{Cnom} = 50\text{A}$	40		ns	
t_r			35		ns	
E_{on}	$R_{Goff} = 12\text{ }\Omega$	$T_j = 125\text{ }^\circ\text{C}$ $V_{GE} = \pm 15\text{V}$	18		mJ	
$t_{d(off)}$			400		ns	
t_f			58		ns	
E_{off}			13		mJ	
$R_{th(j-c)}$	per IGBT			0,25	K/W	



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Characteristics

Symbol	Conditions	min.	typ.	max.	Units
Inverse Diode					
$V_F = V_{EC}$	$I_{Fnom} = 50 \text{ A}; V_{GE} = 0 \text{ V}$		2,2	2,7	V
			2	2,4	V
					V
V_{F0}			1,3	1,5	V
r_F			12	18	mΩ
I_{RRM}	$I_{Fnom} = 50 \text{ A}$		43		A
Q_{rr}	$di/dt = 800 \text{ A}/\mu\text{s}$		15		μC
E_{rr}	$V_{GE} = -15 \text{ V}; V_{CC} = 1200 \text{ V}$				mJ
$R_{th(j-c)D}$	per diode			0,75	K/W
Module					
L_{CE}				30	nH
R_{CC+EE}	res., terminal-chip	$T_{case} = 25 \text{ °C}$	0,75		mΩ
		$T_{case} = 125 \text{ °C}$	1		mΩ
$R_{th(c-s)}$	per module			0,05	K/W
M_s	to heat sink M6		3	5	Nm
M_t	to terminals M5		2,5	5	Nm
w				160	g

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.

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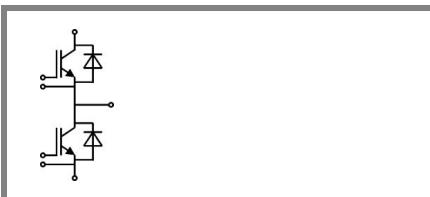
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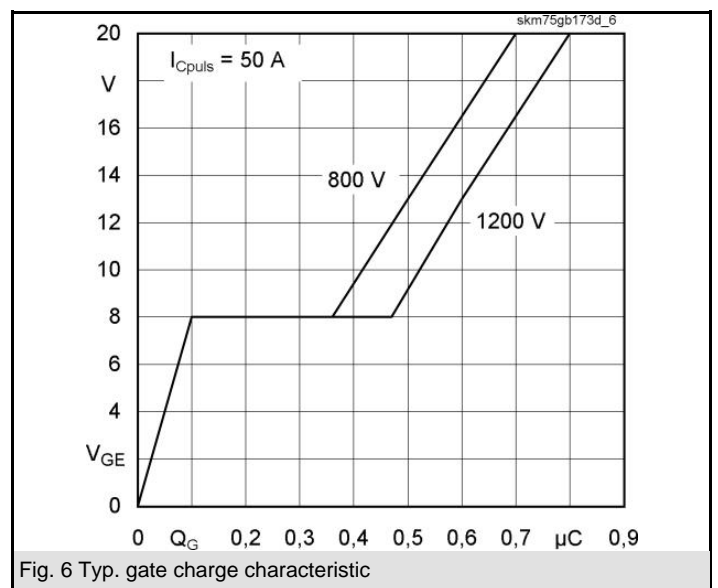
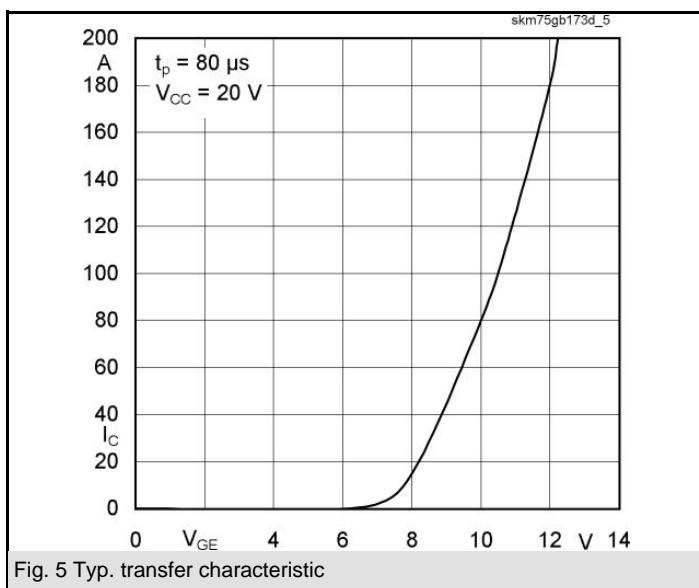
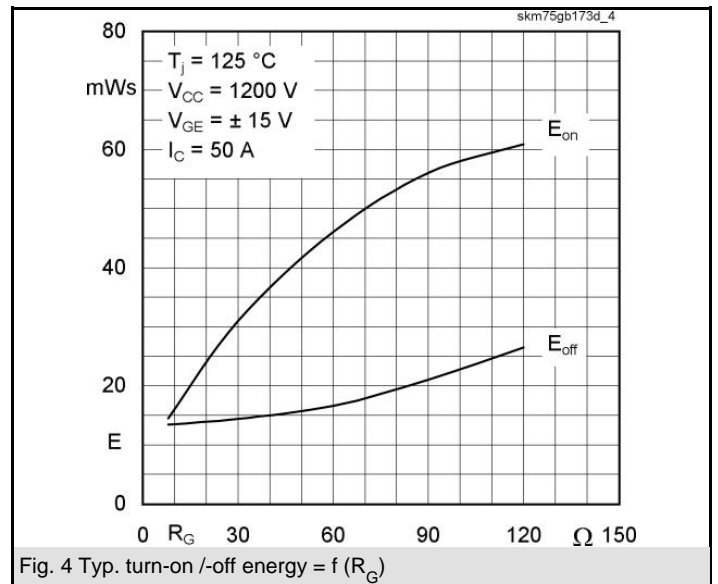
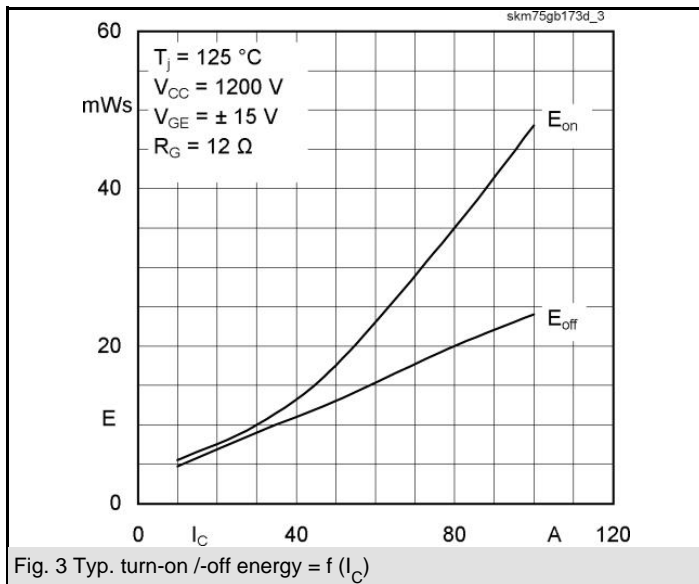
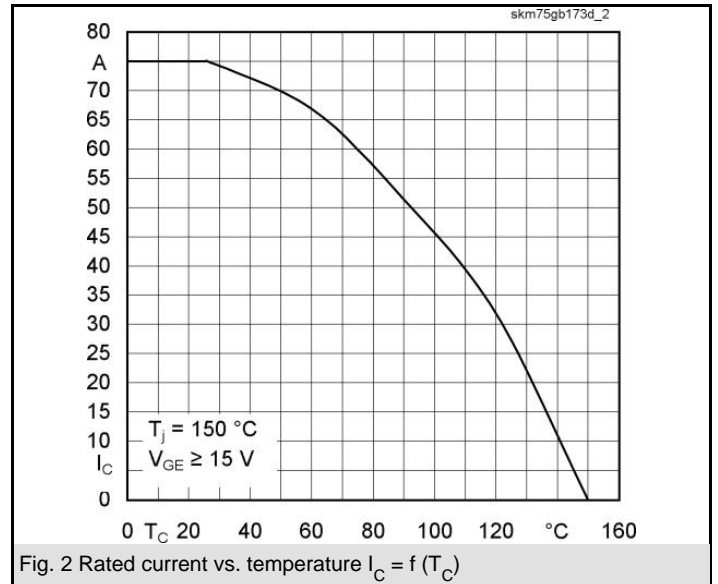
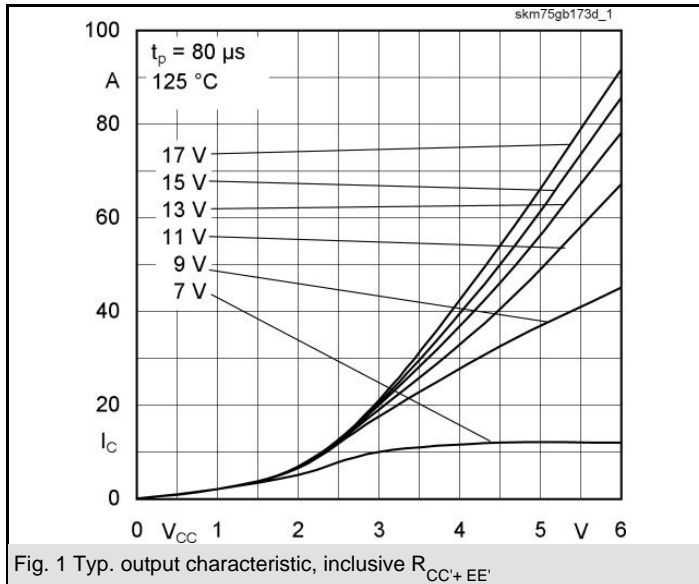
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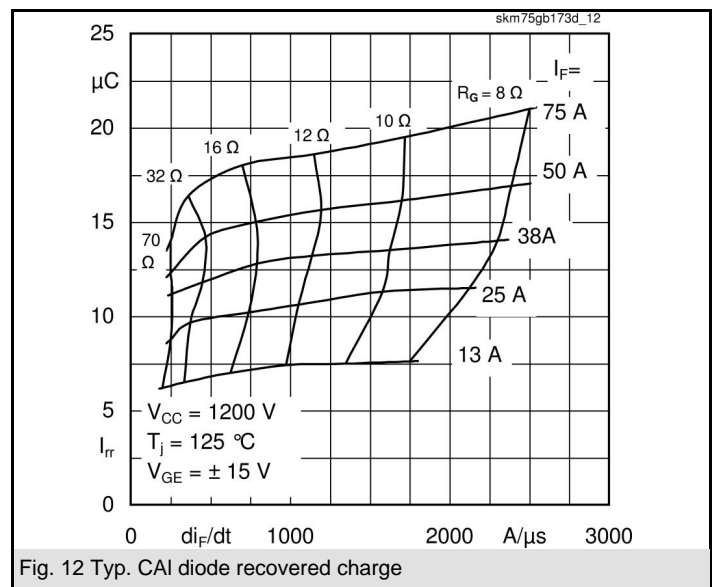
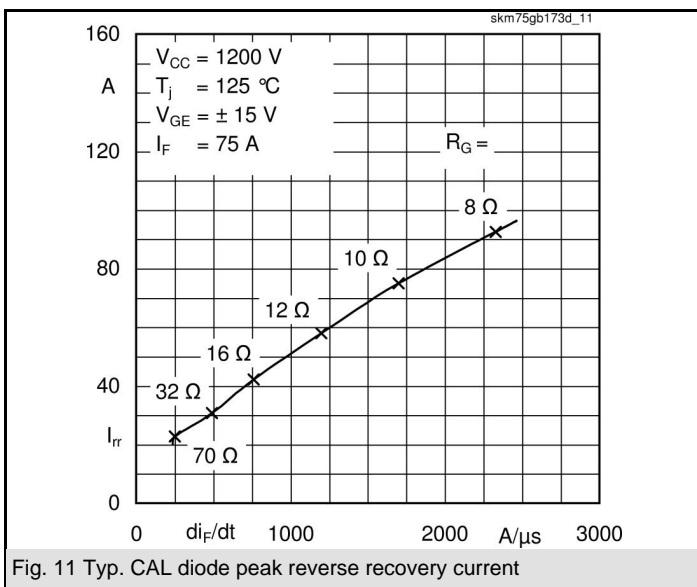
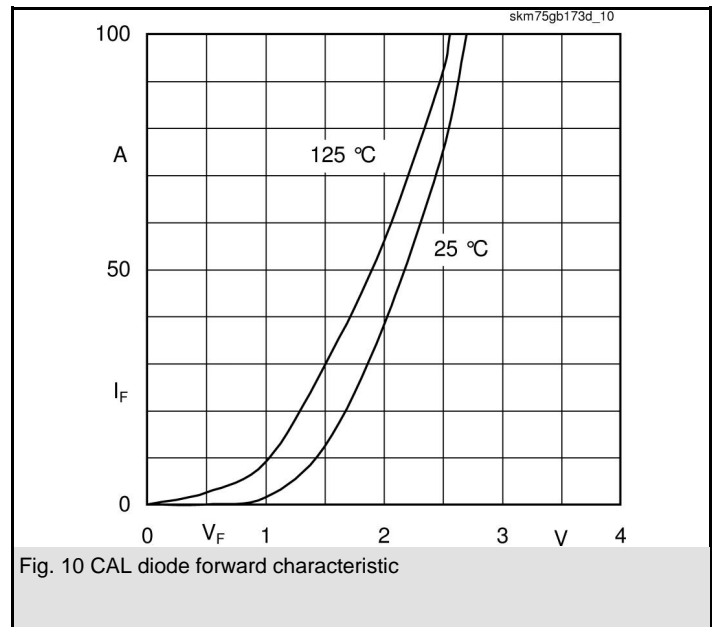
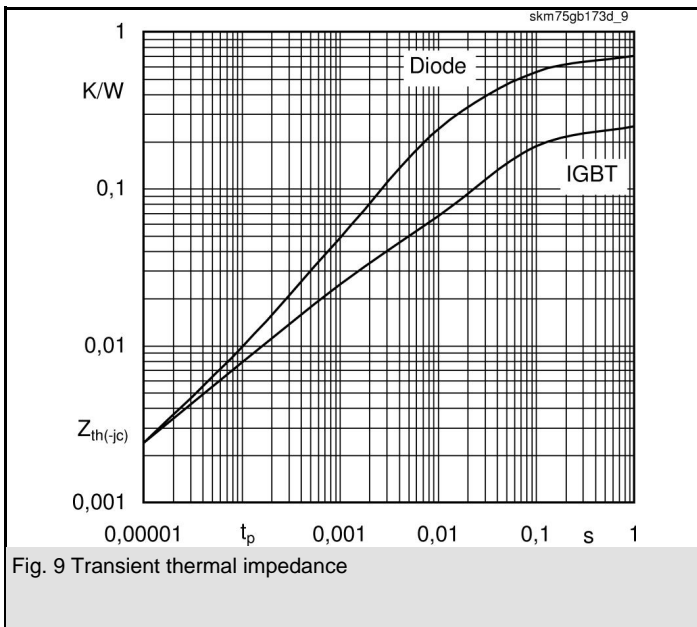
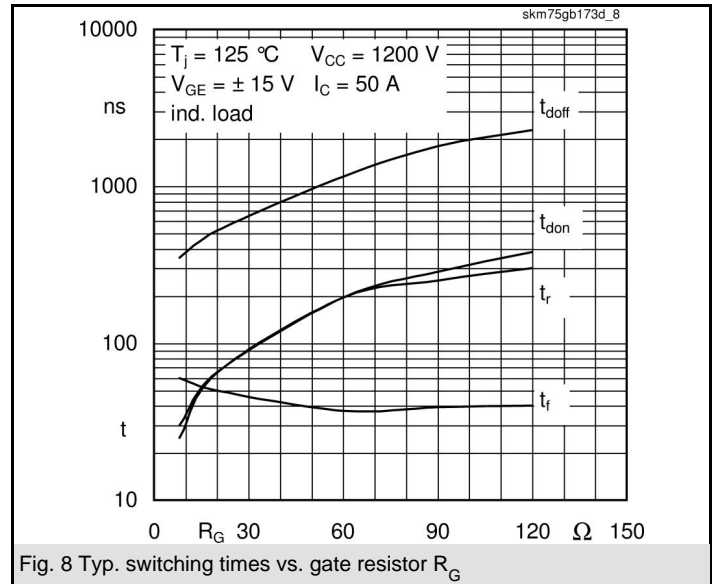
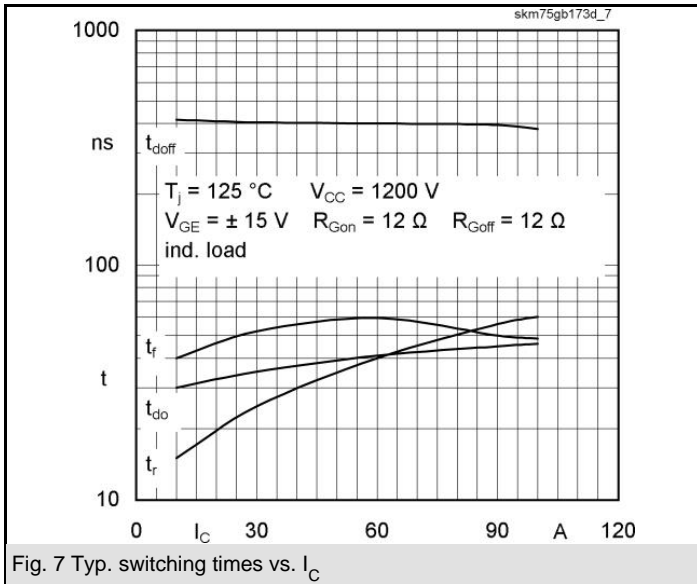
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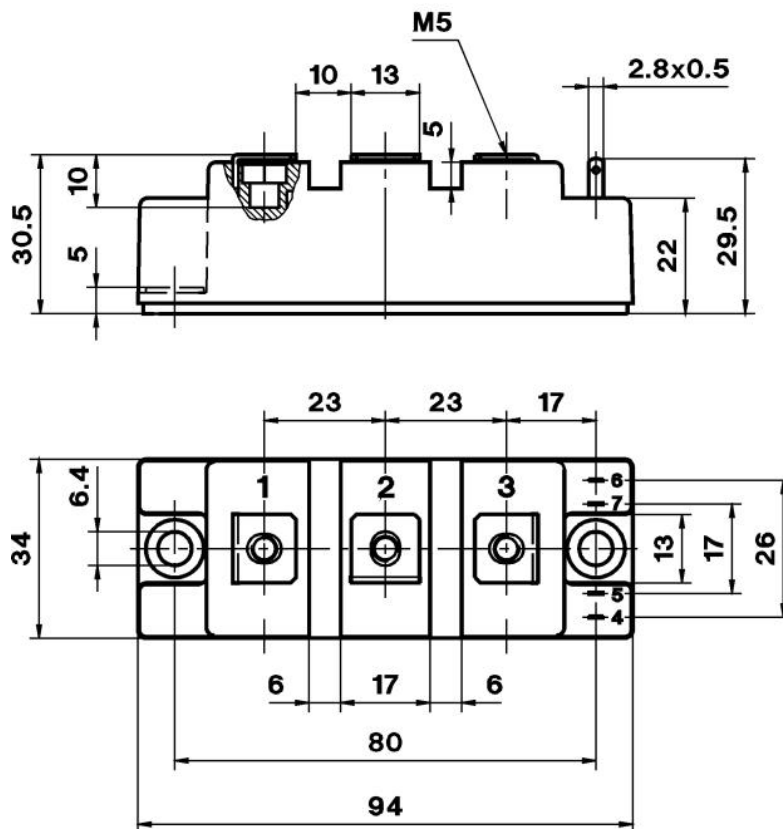
Z_{th}			
Symbol	Conditions	Values	Units
$Z_{th(j-c)I}$			
$R_{\theta j-c}$	$i = 1$	190	mk/W
$R_{\theta j-c}$	$i = 2$	35	mk/W
$R_{\theta j-c}$	$i = 3$	17	mk/W
$R_{\theta j-c}$	$i = 4$	8	mk/W
$\tau_{th j-c}$	$i = 1$	0,1319	s
$\tau_{th j-c}$	$i = 2$	0,0042	s
$\tau_{th j-c}$	$i = 3$	0,0018	s
$\tau_{th j-c}$	$i = 4$	0,0003	s
$Z_{th(j-c)D}$			
$R_{\theta j-c}$	$i = 1$	530	mk/W
$R_{\theta j-c}$	$i = 2$	170	mk/W
$R_{\theta j-c}$	$i = 3$	45	mk/W
$R_{\theta j-c}$	$i = 4$	5	mk/W
$\tau_{th j-c}$	$i = 1$	0,0839	s
$\tau_{th j-c}$	$i = 2$	0,0069	s
$\tau_{th j-c}$	$i = 3$	0,0069	s
$\tau_{th j-c}$	$i = 4$	0,0005	s



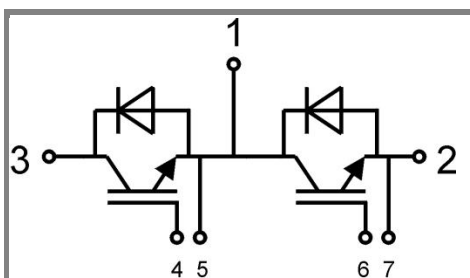


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CASED61



Case D 61



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Case D 61